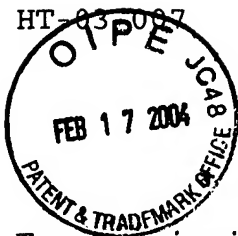


HT-830087



February 9, 2004

To: Commissioner for Patents
P.O.Box 1450
Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject: | Serial No. 10/719,723 11/21/03 |

C.C. Han et al.

A METHOD TO MAKE SMALL ISOLATED
FEATURES WITH PSEUDO-PLANARIZATION
FOR TMR AND MRAM APPLICATIONS

INFORMATION DISCLOSURE STATEMENT

Enclosed is Form PTO-1449, Information Disclosure Citation
In An Application.

The following Patents and/or Publications are submitted to
comply with the duty of disclosure under CFR 1.97-1.99 and
37 CFR 1.56.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service as first class
mail in an envelope addressed to: Commissioner for Patents,
P.O. Box 1450, Alexandria, VA 22313-1450, on February , 2004.

Stephen B. Ackerman, Reg.# 37761

Signature/Date

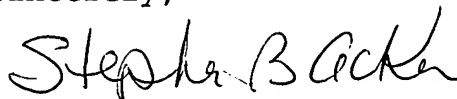
Stephen B. Ackerman 2/12/04

U.S. Patent 6,493,926 to Han et al., "Bi-layer Lift-off Process for High Track Density GMR Head," discloses a method for forming a bi-layer lift-off mask for use in fabricating an abutted junction type GMR read-head sensor with a narrow track-width of less than 0.5 microns.

The following two U.S. Patents discuss small TMR device structures and methods for forming them:

- 1) U.S. Patent 6,562,199 to Shimazawa et al., "Manufacturing Method of Magnetoresistive Element and Film Forming Apparatus."
- 2) U.S. Patent 6,522,573 to Saito et al., "Solid-state Magnetic Memory Using Ferromagnetic Tunnel Junctions."

Sincerely,

A handwritten signature in cursive script that reads "Stephen B. Ackerman".

Stephen B. Ackerman,
Reg. No. 37761

OIPE
 RE CITATION
 ON FEB 17 2004
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DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.